

BUK7905-40AI

N-channel TrenchPLUS standard level FET

Rev. 02 — 16 February 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. The devices include TrenchPLUS current sensing. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Q101 compliant

- Reduced component count due to integrated current sensor
- Suitable for standard level gate drive sources

1.3 Applications

 Electrical Power Assisted Steering (EPAS)

Variable Valve Timing for engines

nexperia

1.4 Quick reference data

Table 1. Quick reference

.	-	• ···			_		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	40	V
I _D	drain current	$V_{GS} = 10 V; T_{mb} = 25 °C;$ see <u>Figure 2</u> ; see <u>Figure 3</u> ;	<u>[1]</u>	-	-	155	A
Static ch	aracteristics						
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 50 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } Figure 7; \text{ see}$ Figure 8		-	4.5	5	mΩ
I _D /I _{sense}	ratio of drain current to sense current	T _j > -55 °C; V _{GS} > 10 V; T _j < 175 °C		450	500	550	

[1] Current is limited by power dissipation chip rating.

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		d
2	ISENSE	current sense	mb	
3	D	drain		
4	KS	Kelvin source		g L E J
5	S	source		
mb	D mounting base; connected to drain		I I I I _{sense} s Kelvin source 03ni64	
			SOT263B	

3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BUK7905-40AI	TO-220	plastic single-ended package; heatsink mounted; 1 mounting hole; 5-lead TO-220	SOT263B		

(TO-220)

4. Limiting values

Table 4.Limiting values

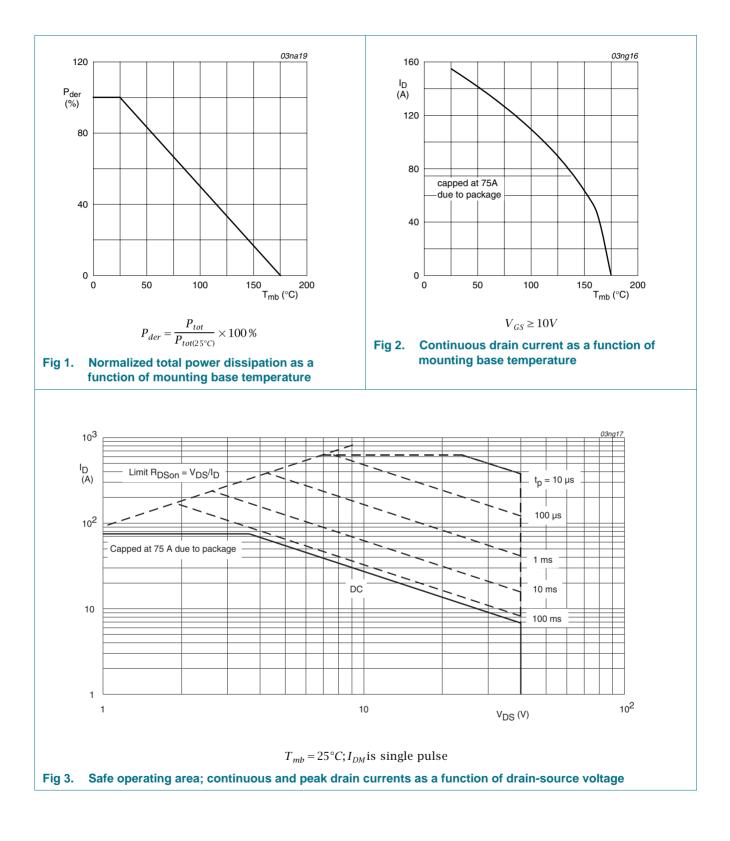
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	40	V
V _{DGR}	drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$		-	40	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V}; \text{ see } \frac{\text{Figure 2}}{\text{Figure 3}};$	[1]	-	155	А
			[2]	-	75	А
		T_{mb} = 100 °C; V_{GS} = 10 V; see <u>Figure 2</u> ;	[2]	-	75	А
I _{DM}	peak drain current	T_{mb} = 25 °C; $t_p \le 10 \ \mu$ s; pulsed; see <u>Figure 3</u>		-	620	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 1</u>		-	272	W
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-dr	ain diode					
I _S	source current	T _{mb} = 25 °C;	[1]	-	155	А
			[2]	-	75	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	620	А
Avalanche	e ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$ I_D = 75 \text{ A}; \text{V}_{\text{sup}} \leq 40 \text{ V}; \text{R}_{\text{GS}} = 50 \Omega; \text{V}_{\text{GS}} = 10 \text{ V}; \\ \text{T}_{j(\text{init})} = 25 ^{\circ}\text{C}; \text{ unclamped} $		-	1.46	J
Electrosta	itic discharge					
V _{esd}	electrostatic discharge voltage	HBM; C = 100 pF; R = 1.5 k Ω		-	4	kV

[1] Current is limited by power dissipation chip rating.

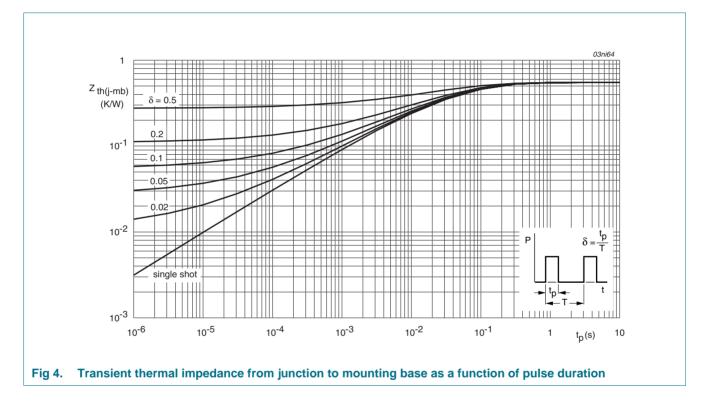
[2] Continuous current is limited by package.

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5. Thermal characteristics

Table 5.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	vertical in still air	-	60	-	K/W
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	see Figure 4	-	-	0.55	K/W



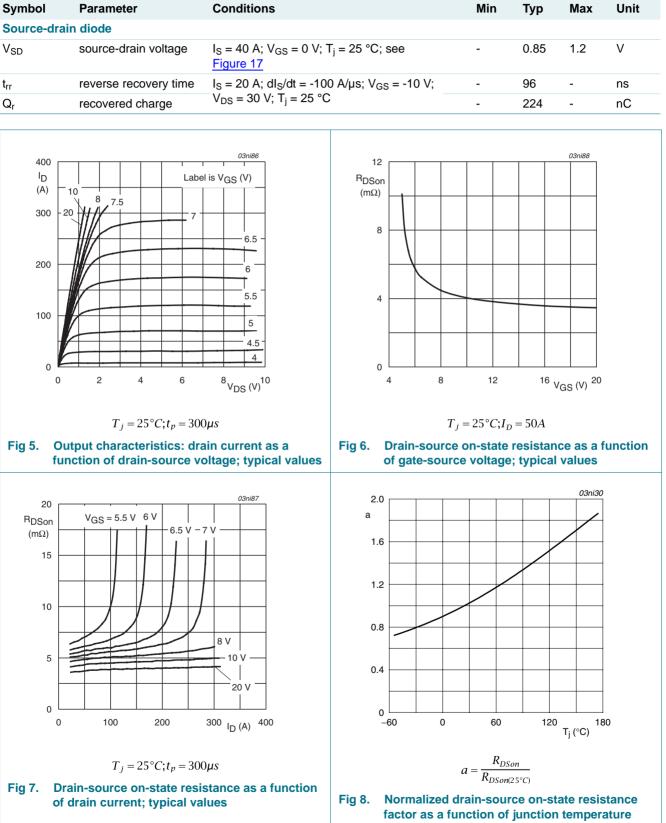
6. Characteristics

Table 6. 0	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V _{(BR)DSS}	drain-source	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	40	-	-	V
	breakdown voltage	I_D = 0.25 mA; V_{GS} = 0 V; T_j = -55 °C	36	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}; \text{ see}$ Figure 9	2	3	4	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 175 °C; see <u>Figure 9</u>	1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}; \text{ see}$ Figure 9	-	-	4.4	V
I _{DSS}	drain leakage current	$V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.1	10	μΑ
		V_{DS} = 40 V; V_{GS} = 0 V; T_j = 175 °C	-	-	500	μA
I _{GSS}	gate leakage current	$V_{DS} = 0 \text{ V}; V_{GS} = 20 \text{ V}; T_{j} = 25 ^{\circ}\text{C}$	-	2	100	nA
		$V_{DS} = 0 \text{ V}; \text{ V}_{GS} = -20 \text{ V}; \text{ T}_{j} = 25 \text{ °C}$	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 50 A; T _j = 25 °C; see <u>Figure 7</u> ; see <u>Figure 8</u>	-	4.5	5	mΩ
		V _{GS} = 10 V; I _D = 50 A; T _j = 175 °C; see <u>Figure 7</u> ; see <u>Figure 8</u>	-	-	9.5	mΩ
I _D /I _{sense}	ratio of drain current to sense current	V_{GS} > 10 V; T _j > -55 °C; T _j < 175 °C	450	500	550	
R _(D-ISENSE) or	drain-ISENSE on-state resistance	V_{GS} = 10 V; I _D = 25 mA; T _j = 25 °C; see Figure 16	0.98	1.08	1.18	Ω
		V _{GS} = 10 V; I _D = 25 mA; T _j = 175 °C; see <u>Figure 16</u>	1.86	2.05	2.24	Ω
Dynamic ch	aracteristics					
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 32 \text{ V}; V_{GS} = 10 \text{ V};$	-	120	127	nC
Q _{GS}	gate-source charge	T _j = 25 °C; see <u>Figure 14</u>	-	19	22	nC
Q _{GD}	gate-drain charge		-	50	60	nC
C _{iss}	input capacitance	V _{GS} = 0 V; V _{DS} = 25 V; f = 1 MHz;	-	4300	5000	pF
C _{oss}	output capacitance	T _j = 25 °C; see <u>Figure 12</u>	-	1400	1670	pF
C _{rss}	reverse transfer capacitance		-	820	1100	pF
t _{d(on)}	turn-on delay time	V_{DS} = 30 V; R_L = 1.2 Ω ; V_{GS} = 10 V;	-	35	-	ns
t _r	rise time	$R_{G(ext)} = 10 \ \Omega; \ T_j = 25 \ ^{\circ}C$	-	115	-	ns
t _{d(off)}	turn-off delay time		-	155	-	ns
t _f	fall time		-	110	-	ns
L _D	internal drain inductance	measured from upper edge of drain mounting base to center of die; $T_j = 25 \text{ °C}$	-	2.5	-	nH
L _S	internal source inductance	measured from source lead to source bond pad; $T_j = 25 \text{ °C}$	-	7.5	-	nH

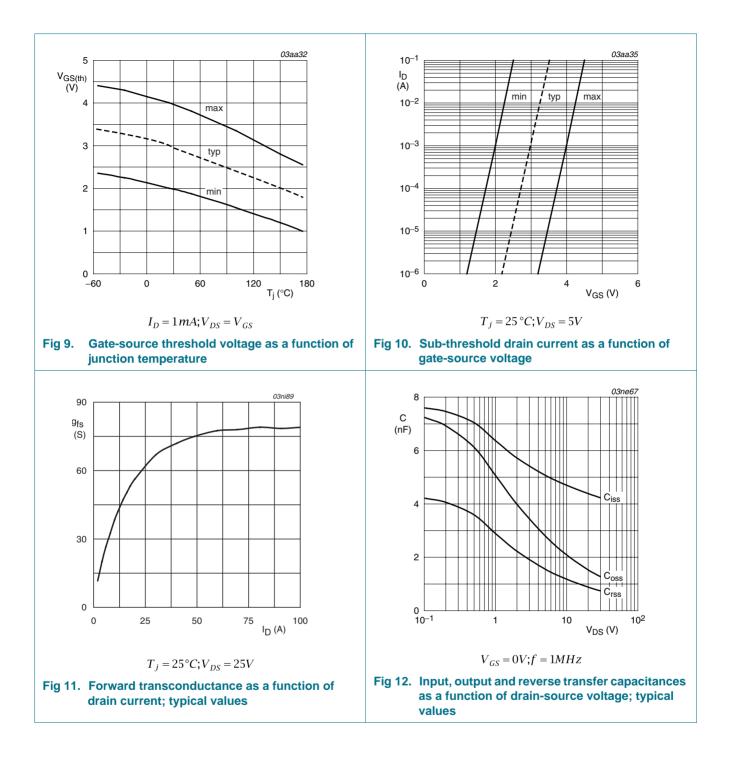
Table 6.

Characteristics ... continued

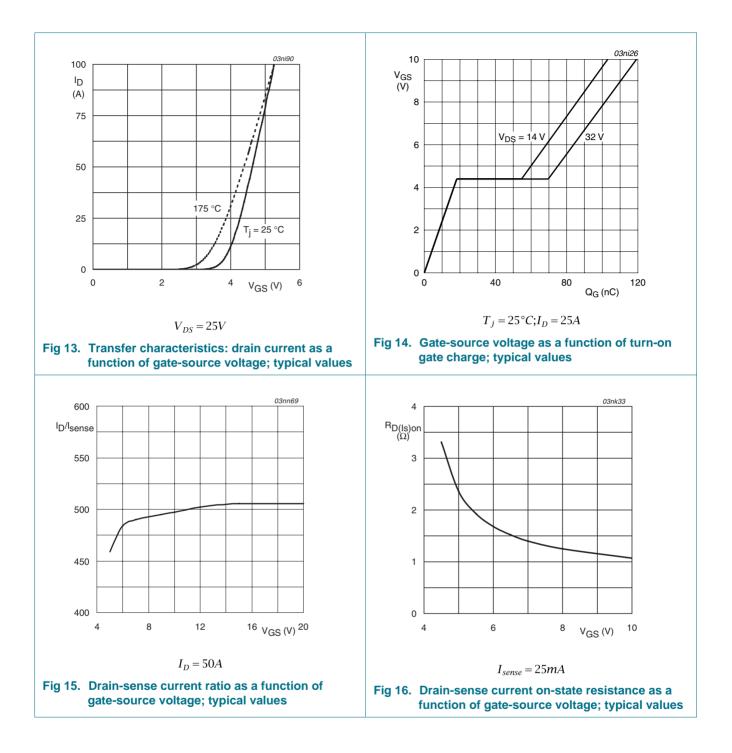
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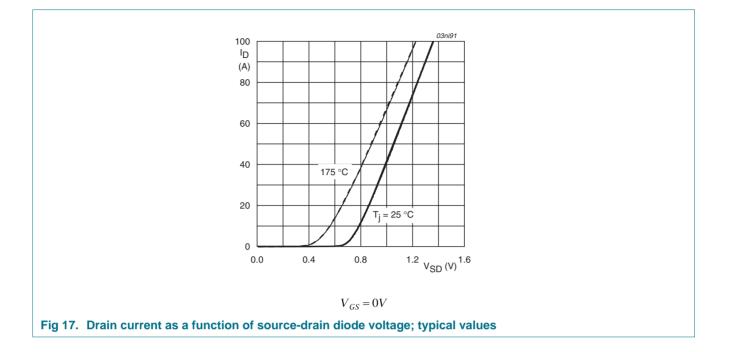
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7. Package outline

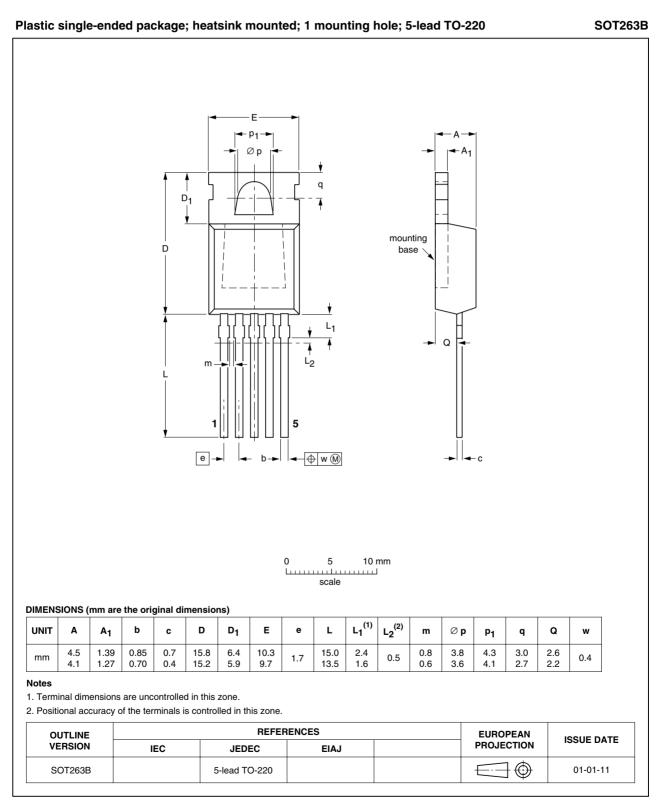


Fig 18. Package outline SOT263B (TO-220)

BUK7905-40AI_2

8. Revision history

Table 7. Revision histo	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BUK7905-40AI_2	20090216	Product data sheet	-	BUK7905_40AI-01
Modifications:		of this data sheet has beer of NXP Semiconductors.	n redesigned to comply w	vith the new identity
	 Legal texts 	have been adapted to the	new company name whe	re appropriate.
BUK7905_40AI-01 (9397 750 12346)	20040209	Product data sheet	-	-

BUK7905-40AI_2

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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N-channel TrenchPLUS standard level FET

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